

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	(integrated adj chip and substrate and thickness and (ground\$3 adj plane)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/22 22:09
L2	0	(integrated adj chip and substrate and thick\$4 and (ground\$3 adj plane)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/22 22:09